

Welcome to IEEE Xplore®

- ☐ Home
- ☐ What Can I Access?
- ☐ Log-out

Tables of Contents

- ☐ Journals & Magazines
- ☐ Conference Proceedings
- ☐ Standards

Search

- ☐ By Author
- ☐ Basic
- ☐ Advanced

Member Services

- ☐ Join IEEE
- ☐ Establish IEEE Web Account
- ☐ Access the IEEE Member Digital Library

 Print FormatYour search matched **21** of **947413** documents.A maximum of **21** results are displayed, **15** to a page, sorted by **Relevance** in **descending** order.

You may refine your search by editing the current search expression or entering a new one in the text box.

Then click **Search Again**.

bonding <and> silicide

Search Again**Results:**Journal or Magazine = **JNL** Conference = **CNF** Standard = **STD****1 Thermoelectric properties and electrode bonding performance for metal silicides***Kajikawa, T.; Sugiyama, T.; Serizawa, M.; Kamio, K.; Koike, M.; Ohta, T.; Omori, M.;*

Thermoelectrics, 2001. Proceedings ICT 2001. XX International Conference on , 8-11 June 2001

Page(s): 236 -239

[\[Abstract\]](#) [\[PDF Full-Text \(381 KB\)\]](#) **IEEE CNF****2 Multilayer capacitors in polycrystalline diamond by rapid thermal annealing***Kosel, P.B.; Monreal, R.; Fries-Carr, S.; Weimer, J.; Heidger, S.; Wu, R.L.C.;*

Aerospace and Electronics Conference, 1998. NAECON 1998.

Proceedings of the IEEE 1998 National , 13-17 July 1998

Page(s): 255 -262

[\[Abstract\]](#) [\[PDF Full-Text \(460 KB\)\]](#) **IEEE CNF****3 Buried metallic layers in silicon using wafer fusion bonding techniques***Goh, W.L.; Armstrong, B.M.; Gamble, H.S.;*

Electrotechnical Conference, 1994. Proceedings., 7th Mediterranean , 12-14 April 1994

Page(s): 625 -628 vol.2